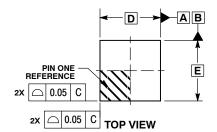
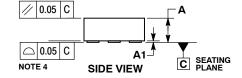
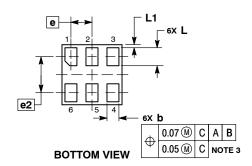


XLLGA6 1.00x1.00, 0.35P CASE 713AD **ISSUE O**

DATE 21 OCT 2014







NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS.
- 2. DIMENSION & APPLIES TO THE PLATED TERMINALS AND IS MEASURED BETWEEN 0.15 AND 0.25 MM
- FROM THE TERMINAL TIPS.

 COPLANARITY APPLIES TO ALL OF THE TERMINALS.

	MILLIMETERS		
DIM	MIN	MAX	
Α		0.40	
A1	0.00	0.05	
۵	0.17	0.23	
D	1.00 BSC		
E	1.00 BSC		
e	0.35 BSC		
e2	0.60 BSC		
L	0.27	0.33	
L1	0.05	REF	

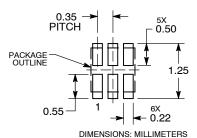
GENERIC MARKING DIAGRAM*



XX = Specific Device Code

= Date Code

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	XLLGA6 1.00X1.00, 0.35P		PAGE 1 OF 1

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^{*}This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.